# MA3X789 (MA789)

## Silicon epitaxial planar type

For super high speed switching For small current rectification

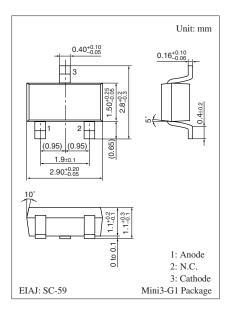
#### ■ Features

- Forward current (Average)  $I_{F(AV)} = 500$  mA rectification is possible
- Reverse voltage  $V_R = 60 \text{ V}$  is guaranteed

### ■ Absolute Maximum Ratings $T_a = 25$ °C

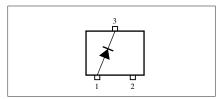
Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	60	V
Maximum peak reverse voltage	$V_{RM}$	60	V
Forward current (Average)	I <sub>F(AV)</sub>	500	mA
Non-repetitive peak forward surge current *	$I_{FSM}$	2	A
Junction temperature	$T_{j}$	125	°C
Storage temperature	$T_{stg}$	-55 to +125	°C

Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)



#### Marking Symbol: M3W

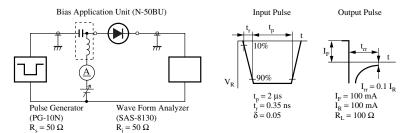
#### Internal Connection



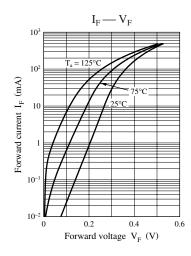
### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

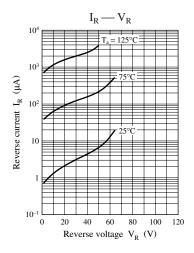
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_F$	$I_F = 500 \text{ mA}$			0.65	V
Reverse current	$I_R$	$V_R = 50 \text{ V}$			100	μΑ
Terminal capacitance	C <sub>t</sub>	$V_R = 0 V, f = 1 MHz$		60		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$		4.5		ns
		$I_{rr} = 0.1 I_{R}, R_{L} = 100 \Omega$				

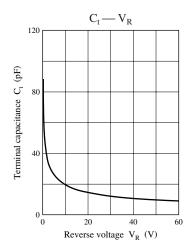
- $Note) \ 1. \ Measuring \ methods \ are \ based \ on \ JAPANESE \ INDUSTRIAL \ STANDARD \ JIS \ C \ 7031 \ measuring \ methods \ for \ diodes.$ 
  - This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 100 MHz.
- 4. \*: t<sub>rr</sub> measurement circuit

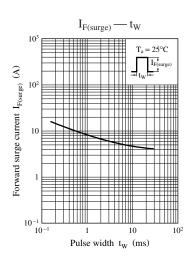


Note) The part number in the parenthesis shows conventional part number.









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